

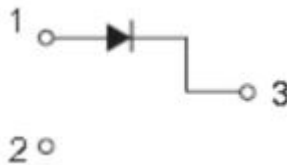
MMBD4148 SURFACE MOUNT FAST SWITCHING DIODE



Features

- High Conductance
- Fast Switching
- Surface Mount Package Ideally Suited for Automatic Insertion
- For General Purpose and Switching
- Plastic Material - UL Recognition Flammability Classification 94V-0
- This is a Pb - Free Device
- All SMC parts are traceable to the wafer lot
- Additional testing can be offered upon request

Schematic & Pin Configuration



Mechanical Characteristics

- Case: SOT-23, Molded Plastic
- Terminals: Plated leads Solderable per MIL-STD-202, Method 208
- Mounting Position: Any
- Weight: 0.008g

Maximum Ratings@ $T_A=25^\circ\text{C}$ unless otherwise specified

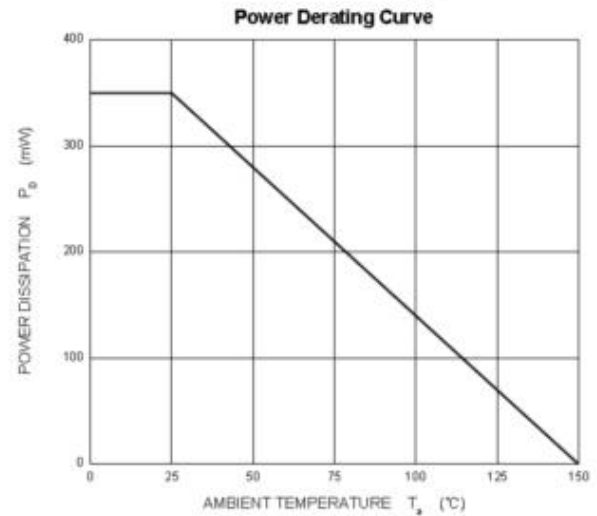
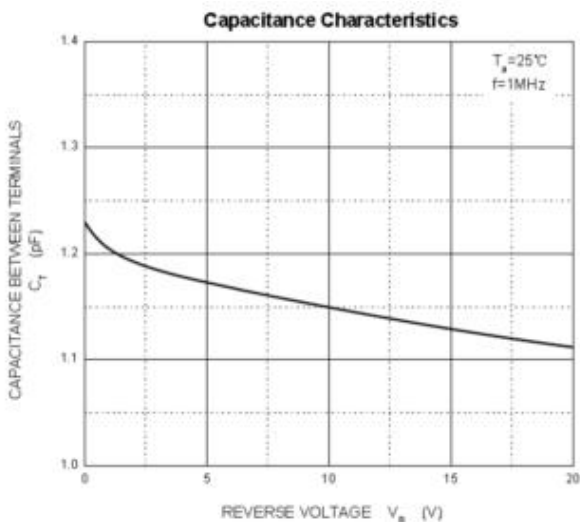
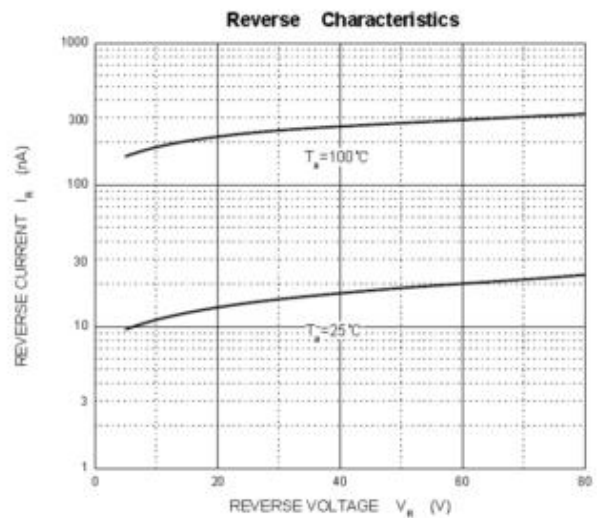
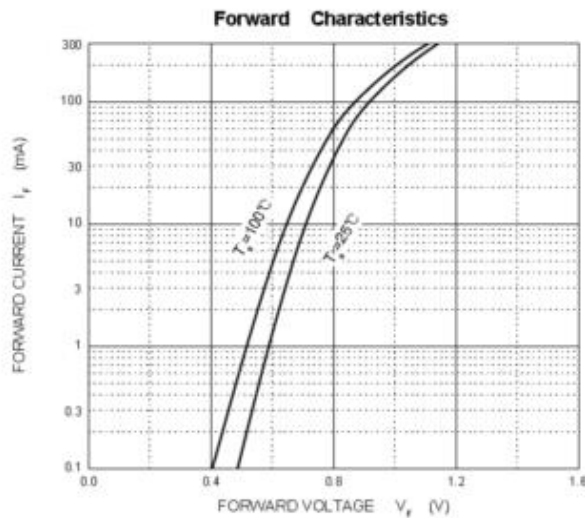
Characteristic	Symbol	Limits	Units
Non-Repetitive Peak Reverse Voltage	V_{RM}	100	V
Peak Repetitive Reverse Voltage	V_{RRM}	75	V
Working Peak Reverse Voltage	V_{RWM}		
DC Blocking Voltage	V_R		
RMS Reverse Voltage	$V_{R(RMS)}$	53	V
Forward Continuous Current	I_F	300	mA
Average Rectified Output Current	I_O	150	mA
Non-Repetitive Peak Forward Surge Current @ $t=8.3\text{ms}$	I_{FSM}	2.0	A
Power Dissipation	P_d	350	mW
Typical Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	357	$^\circ\text{C/W}$
Operating and Storage Temperature Range	T_J, T_{STG}	-55 to +150	$^\circ\text{C}$

Electrical Characteristics @ $T_A=25^\circ\text{C}$ unless otherwise specified

Characteristic	Symbol	Min	Max	Units	Test Condition
Forward Voltage *	V_F	-	0.715 0.855 1.00 1.25	V	@ $I_F=1\text{mA}$ @ $I_F=10\text{mA}$ @ $I_F=50\text{mA}$ @ $I_F=150\text{mA}$
Reverse Leakage Current *	I_R	-	2.5 25	μA nA	@ $V_R=75\text{V}$ @ $V_R=20\text{V}$
Junction Capacitance	C_j	-	2.0	pF	$V_R=0\text{V}$, $f=1.0\text{MHz}$
Reverse Recovery Time	t_{rr}	-	4.0	ns	$I_F=I_R=10\text{mA}$, $I_{RR}=0.1 \times I_R$

* Pulse width < 300 μs , duty cycle < 2%
Note: 1. Device mounted on fiberglass substrate $40 \times 40 \times 1.5\text{mm}$

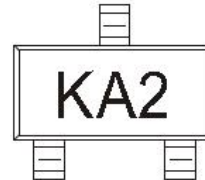
Ratings and Characteristics Curves



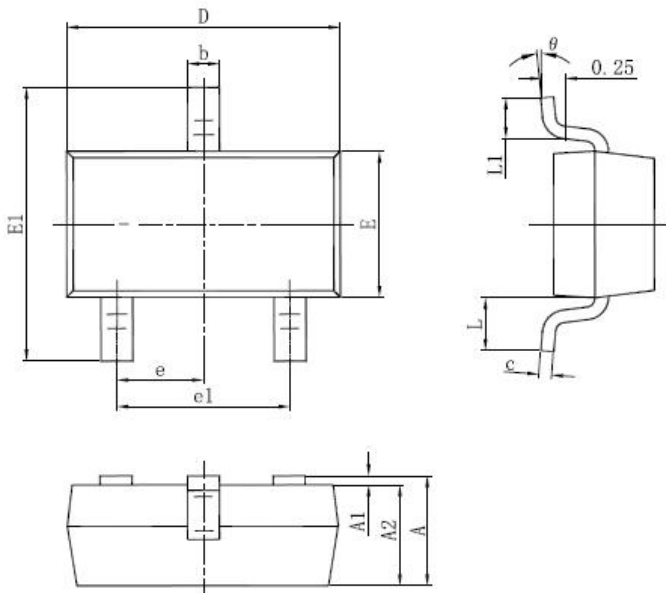
Ordering Information

Device	Package	Shipping
MMBD4148	SOT-23 (Pb-Free)	3000pcs / reel

For information on tape and reel specifications, including part orientation and tape sizes, please refer to our tape and reel packaging specification.

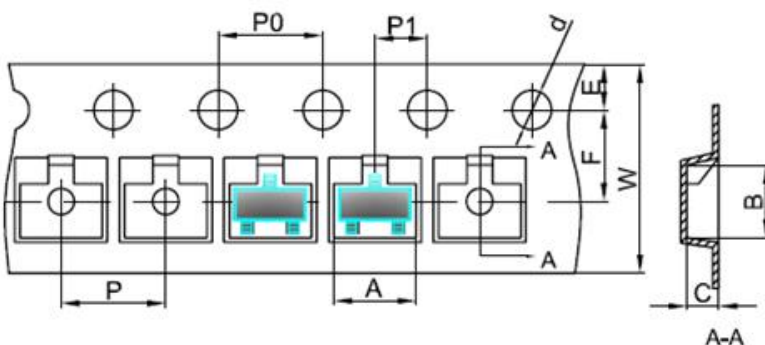
Marking Diagram


KA2 = Marking Code

Mechanical Dimensions SOT-23


SYMBOL	Millimeters		Inches	
	MIN.	MAX.	MIN.	MAX.
A	0.890	1.150	0.035	0.045
A1	0.000	0.100	0.000	0.004
A2	0.900	1.050	0.035	0.041
b	0.300	0.500	0.012	0.020
c	0.076	0.170	0.003	0.007
D	2.650	3.050	0.104	0.120
E	1.190	1.400	0.047	0.055
E1	2.100	2.550	0.083	0.100
e	0.950 TYP.		0.037 TYP.	
e1	1.780	2.050	0.070	0.081
L	0.550 REF.		0.022 REF.	
L1	0.300	0.500	0.012	0.020
θ	0°	8°	0°	8°

Note: If date code is before 2016 year, please contact with factory about marking.

Carrier Tape Specification SOT-23


SYMBOL	Millimeters	
	Min.	Max.
A	3.05	3.25
B	2.67	2.87
C	1.12	1.32
d	1.40	1.60
E	1.65	1.85
F	3.40	3.60
P	3.90	4.10
P0	3.90	4.10
P1	1.90	2.10
W	7.90	8.30

- China - Germany - Korea - Singapore - United States •
- <http://www.smc-diodes.com> - sales@smc-diodes.com •

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